

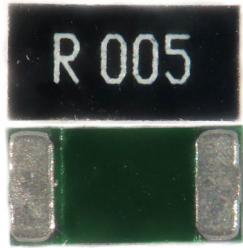


**Thin Film Technology Corp.**

**Product Family:** 2-Terminal Current Sensing Power Resistor

**Part Number Series:** MPC Series

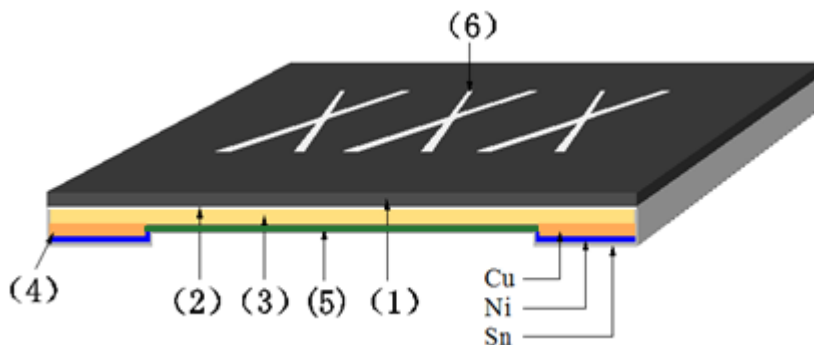


	<p><b>Construction:</b></p> <ul style="list-style-type: none"> <li>• Metal foil resistive element</li> <li>• Epoxy-resin overcoat</li> <li>• Non-wrapped electrodes</li> <li>• Inherently anti-sulfur</li> <li>• 100% matte tin over Ni terminations</li> <li>• RoHS compliant and Pb free</li> </ul>	<p><b>Features:</b></p> <ul style="list-style-type: none"> <li>• 0201, 0402, 0603, 0805 and 1206 English case sizes</li> <li>• Resistances from 1mΩ~50mΩ</li> <li>• TCR down to ±50ppm/°C</li> <li>• Tolerance down to ±0.5%</li> <li>• Thicknesses down to 0.35mm maximum</li> </ul>
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**Description:**

These low resistance, metal foil, current sensing chip resistors exhibit excellent performance with a very low height profile. They are useful in many current sensing applications. High volume production suitable for commercial and special applications.

**Product Construction:**

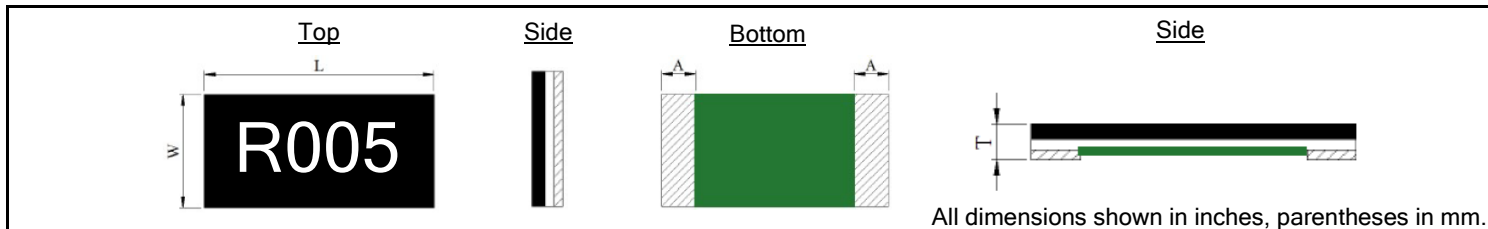


Number	Description
1	Substrate (Glass Epoxy)
2	Adhesive (Epoxy Resin)
3	Resistor Element (Cu-Alloy)
4	Terminals (100% Matte Sn)
5	Protective Coating (Epoxy Resin)
6	Marking

**Part Numbering:** Ex: MPC1206QR005FF-T5

Series Name	English Size (Metric Size)	Temp. Coefficient of Resistance (TCR)	Resistance Value	Resistance Tolerance	Internal Code	T&R Packaging Quantity
MPC	0201 (0603) 0402 (1005) 0603 (1608) 0805 (2012) 1206 (3216)	Q = ±50ppm/°C D = ±75ppm/°C R = ±100ppm/°C G = ±150ppm/°C S = ±200ppm/°C	Ex. R005 = 0.005Ω 2M50 = 0.0025Ω (4 digits)	D = ±0.5% F = ±1.0%	F = Face Down	-T5 = 5,000 -T10 = 10,000

**Product Dimensions:**



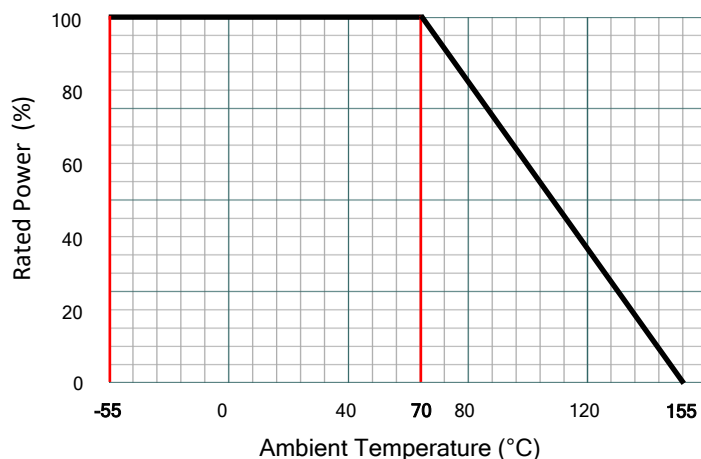
All dimensions shown in inches, parentheses in mm.

Dimension (Metric)	Resistance Range	L	W	T	A
MPC0201 (0603)	10mΩ, 20mΩ	0.024 ±0.004 (0.60 ±0.10)	0.012 ±0.004 (0.30 ±0.10)	0.010 +0.004/-0.002 (0.25+0.10/-0.05)	0.006 ±0.004 (0.15 ±0.10)
MPC0402 (1005)	2.5mΩ~3mΩ	0.039 ±0.004 (1.00 ±0.10)	0.022 ±0.004 (0.55 ±0.10)	0.012 ±0.002 (0.30 ±0.05)	0.012 ±0.04 (0.30 ±0.10)
	5mΩ~50mΩ				0.009 ±0.04 (0.23 ±0.10)
MPC0603 (1608)	2mΩ	0.063 ±0.010 (1.60 ±0.25)	0.031 ±0.010 (0.80 ±0.25)	0.014 ±0.08 (0.35 ±0.20)	0.018 ±0.008 (0.45 ±0.20)
	2.5mΩ~3mΩ				0.014 ±0.008 (0.35 ±0.20)
	4mΩ~20mΩ				0.012 ±0.008 (0.30 ±0.20)
MPC0805 (2012)	1mΩ~1.5mΩ	0.079 ±0.010 (2.00 ±0.25)	0.050 ±0.010 (1.25 ±0.25)	0.016 ±0.08 (0.40 ±0.20)	0.028 ±0.008 (0.70 ±0.20)
	2mΩ~2.5mΩ				0.024 ±0.008 (0.60 ±0.20)
	3mΩ~20mΩ				0.016 ±0.008 (0.40 ±0.20)
MPC1206 (3216)	1mΩ~1.5mΩ	0.126 ±0.009 (3.20 ±0.25)	0.063 ±0.009 (1.60 ±0.25)	0.016 ±0.08 (0.40 ±0.20)	0.050 ±0.012 (1.25 ±0.30)
	2mΩ				0.041 ±0.012 (1.05 ±0.30)
	3mΩ				0.031 ±0.012 (0.80 ±0.30)
	4mΩ~20mΩ				0.024 ±0.012 (0.60 ±0.30)

**Electrical Specifications:**

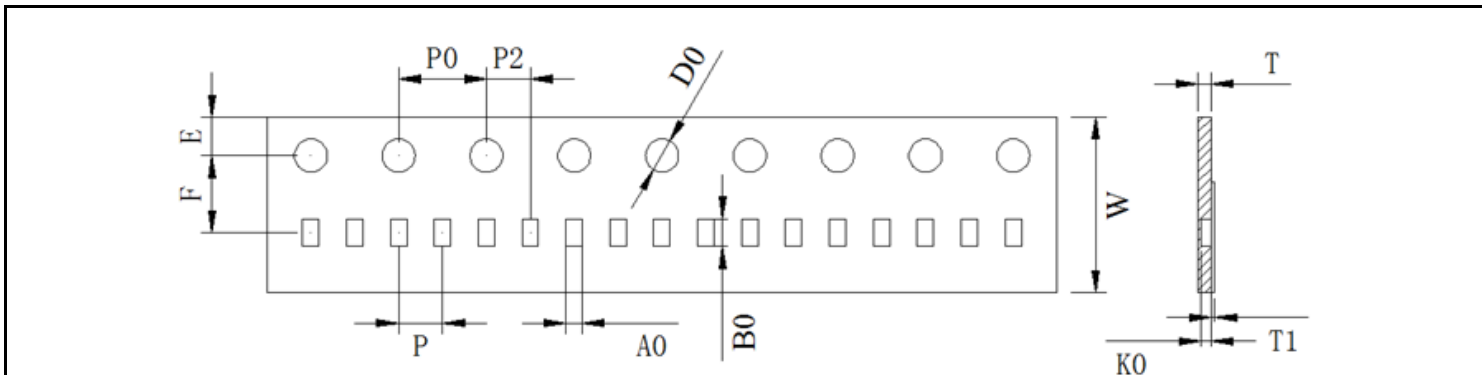
Type	MPC0201		MPC0402					MPC0603			
Metric Size	0603		1005					1608			
Power Rating	1/4W		1/3W			1/4W		1/3W			
Resistance Range (mΩ)	10	20	2.5~3	5~19	20	21~25	40~50	2	2.5~4	5	6~20
Resistance Tolerance (code)	±1.0% (F)	±0.5% (D) ±1.0% (F)	±1.0% (F)		±0.5% (D) ±1.0% (F)	±1.0% (F)		±1.0% (F)		±0.5% (D) ±1.0% (F)	±1.0% (F)
TCR ppm/°C (code)	±200 (S)	±100 (R)	±150 (G)	±100 (R)			±150 (G)	±100 (R)		±75 (D)	
Rated Voltage	√(Power x Resistance)										
Operating Temp. Range	-55°C~+155°C										
Packaging (code)	10,000 pcs/reel (-T10)							5,000 pcs/reel (-T5)			

Type	MPC0805				MPC1206	
Metric Size	2012				3216	
Power Rating	1/2W				1W	
Resistance Range (mΩ)	1	1.5	2~5	6~20	1~4	5~20
Resistance Tolerance (code)	±1.0% (F)					
TCR ppm/°C (code)	±150 (G)	±100 (R)	±75 (D)	±50 (Q)	±75 (D)	±50 (Q)
Rated Voltage	√(Power x Resistance)					
Operating Temp. Range	-55°C~+155°C					
Packaging (code)	5,000 pcs/reel (-T5)					

**Power Derating Curve:****Reliability Specifications:**

Test	Procedure	Specifications
<b>Short Time Over Load</b> IEC60115-1 4.13	$P = 2.5P_r$ ; $T = 25 \pm 2^\circ\text{C}$ ; $t = 5\text{sec.}$	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>High Temp. Exposure</b> IEC60115-1 4.25	$T = +155 \pm 2^\circ\text{C}$ ; $t = 1000\text{h}$	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Low Temp. Storage</b> IEC60115-1 4.25	$T = -55 \pm 2^\circ\text{C}$ ; $t = 1000\text{h}$	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Moisture Load Life</b> IEC60115-1 4.25	$V_{\text{test}} = V_{\text{max}}$ ; $T = 60 \pm 2^\circ\text{C}$ ; $\text{RH} = 95\%$ ; $t = 90\text{min ON}, 30\text{min OFF}, 1000\text{h}$	$\pm(2.0\% + 0.5\text{m}\Omega)$
<b>Temperature Humidity</b> IEC60115-1 4.25	0201: $T = 40 \pm 2^\circ\text{C}$ ; $\text{RH} = 90\%$ ; $t = 1000\text{h}$	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Thermal Shock</b> IEC60115-1 4.19	0201: $-55^\circ\text{C}$ 30min. $\rightarrow$ R.T. 1min. $\rightarrow$ $+155^\circ\text{C}$ 30min. $\rightarrow$ R.T. 1min., 1000 cycles 0402-1206: $-55^\circ\text{C}$ 30min. $\rightarrow$ R.T. 3min. $\rightarrow$ $+150^\circ\text{C}$ 30min. $\rightarrow$ R.T. 3min., 100 Cycles	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Load Life at 70°C</b> IEC60115-1 4.25	$V_{\text{test}} = V_{\text{max}}$ ; $T = 70 \pm 2^\circ\text{C}$ ; $t = 90\text{min ON}, 30\text{min OFF}, 1000\text{h}$ 0201: $V_{\text{test}} = V_{\text{max}}$ ; $T = 70 \pm 2^\circ\text{C}$ ; $t = 90\text{min ON}, 30\text{min OFF}, 1000\text{h}$	0201: $\pm(1.0\% + 0.5\text{m}\Omega)$ 0402-1206: $\pm(2.0\% + 0.5\text{m}\Omega)$
<b>Solderability</b> IEC60115-1 4.17	Dip into solder at $T = 245 \pm 5^\circ\text{C}$ , $t = 3\text{sec.}$	>95% coverage with new solder
<b>Resistance to Solder Heat</b> IEC60115-1 4.18	Through Reflow. Parts are subjected to 3 reflow cycles	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Mechanical Shock</b> IEC60115-1 4.21	0201: $F = 50 \pm 5\text{G}$ , $t = 11 \pm 1\text{ms.}$ 0402-1206: $a = 100\text{G}$ , $t = 11\text{ms}$ , 5 times shock	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Substrate Bending</b> IEC60115-1 4.33	Span between fulcrums = 90mm Bend width = 2mm Test board = Glass-epoxy board Thickness = 1.6mm Duration = 10 sec.	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Terminal Strength</b>	0201: $F = 3.4\text{N}$ ; $t = 60 \pm 1\text{sec}$	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Highly Accelerated Stress Test</b>	0201: $T = 121 \pm 2^\circ\text{C}$ , $p = 30\text{PSIA}$ , $t = 48\text{h}$	$\pm(1.0\% + 0.5\text{m}\Omega)$
<b>Vibration</b>	0201: $f = 10 \sim 2,000\text{Hz}$ , $a = 15\text{G} \pm 1.5\text{G}$ , $t = 20\text{min}$ , 12 cycles	$\pm(1.0\% + 0.5\text{m}\Omega)$

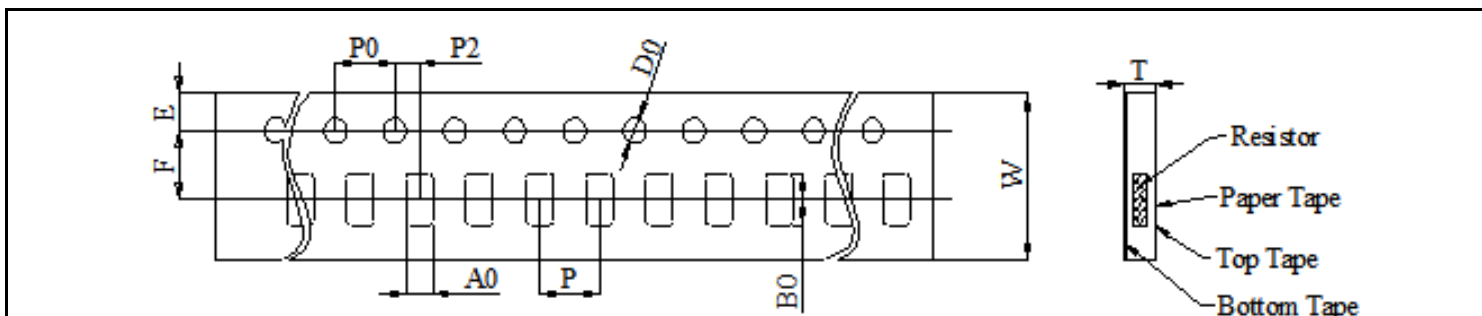
**Plastic Tape Dimensions:**



All dimensions in mm.

Size	W	P0	P1	P2	A0	B0	D0	F	E	T	T1	K0
0201	8.00 ±0.20	4.00 ±0.10	2.00 ±0.10	2.00 ±0.10	0.38 ±0.10	0.68 ±0.10	1.50 ±0.10	3.50 ±0.10	1.75 ±0.10	0.45 ±0.05	Max 0.10	0.30 ±0.05

**Paper Tape Dimensions:**



All dimensions in mm.

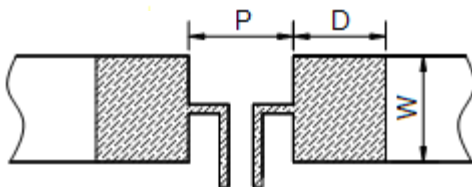
Size	W	P0	P	P2	A0	B0	D0	F	E	T
0402	8.00 ±0.30	4.00 ±0.10	2.00 ±0.10	2.00 ±0.10	0.65 ±0.10	1.10 ±0.10	1.50 ±0.10	3.50 ±0.10	1.75 ±0.10	0.42 ±0.05
0603	8.00 ±0.30	4.00 ±0.10	4.00 ±0.10	2.00 ±0.10	0.98 ±0.10	1.85 ±0.10	1.50 ±0.10	3.50 ±0.10	1.75 ±0.10	0.60 ±0.05
0805	8.00 ±0.30	4.00 ±0.10	4.00 ±0.10	2.00 ±0.10	1.55 ±0.10	2.30 ±0.10	1.50 ±0.10	3.50 ±0.10	1.75 ±0.10	0.75 ±0.10
1206	8.00 ±0.30	4.00 ±0.10	4.00 ±0.10	2.00 ±0.10	2.05 ±0.20	3.65 ±0.20	1.50 ±0.10	3.50 ±0.10	1.75 ±0.10	0.75 ±0.10

**Reel Dimensions:**

Size	Quantity	A	N	W1
0201	10,000 pcs/reel	178 ±5.00	60.0 ±2.00	9.00 ±1.00
0402				
0603	5,000 pcs/reel	178 ±5.00	60.0 ±2.00	9.00 ±1.00
0805				
1206				

All dimensions in mm.

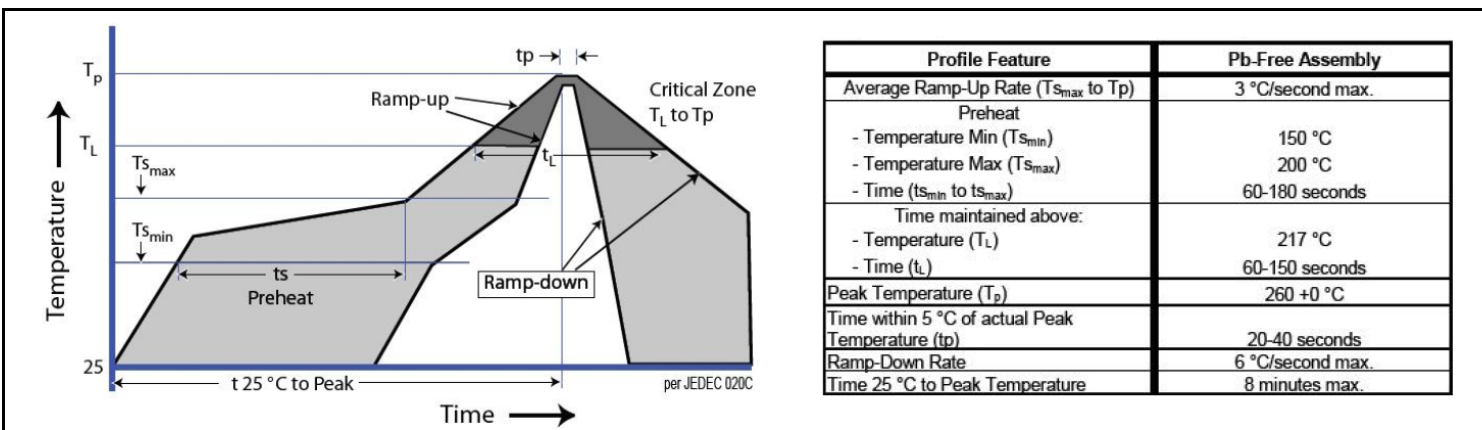
**Recommended Land Pattern:**



All dimensions in mm.

Size	Resistance Range	P	W	D
0201	10mΩ, 20mΩ	0.25	0.33	0.20
0402	2.5mΩ~3mΩ	0.35	0.60	0.60
	5mΩ~25mΩ, 40mΩ~50mΩ	0.40		
0603	2mΩ	0.38	0.92	1.41
	2.5mΩ~3mΩ	0.50		1.35
	4mΩ~20mΩ	0.60		1.30
0805	1mΩ	0.40	1.44	1.60
	1.5mΩ~2.5mΩ	0.50		1.55
	3mΩ~20mΩ	0.80		1.40
1206	1mΩ~1.5mΩ	0.50	1.84	2.15
	2mΩ	0.60		2.10
	3mΩ~20mΩ	1.20		1.80

**Soldering Profile:**



**Marking Information:**

0201~0402: no marking	0603: 2 digit marking Ex: 10mΩ = 11	0805: 3 digit marking Ex: 10mΩ = 100	1206: 4 digit marking Ex: 10mΩ = 10R0

**Storage Conditions:**

**Environment Conditions:**  
 Products should be stored under the following environmental conditions.

- Temperature: +5 to +35°C
- Humidity: 45 to 85% relative humidity
- Do not keep products in environments where they may be subject to particulate contamination or harmful gases such as sulfuric acid or hydrogen chloride as it may cause oxidization on electrodes, resulting in poor solderability.
- Products should be stored in a space that does not expose it to high temperatures, vibration, or direct sunlight.
- Products should be stored in the original airtight packaging until use.